

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
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EPAS ID: PAT6699554

SUBMISSION TYPE:	CORRECTIVE ASSIGNMENT
NATURE OF CONVEYANCE:	Corrective Assignment to correct the APPLICATION NUMBER previously recorded on Reel 056066 Frame 0987. Assignor(s) hereby confirms the ASSIGNMENT.
CONVEYING PARTY DATA	
Name	Execution Date
JI HYE HAN	02/24/2021
JUNG MIN KIM	02/24/2021
JAE SEOK YI	02/24/2021
HYE JIN PARK	02/24/2021
BYUNG WOO KANG	02/26/2021
JEONG RYEOL KIM	03/02/2021
BON SEOK KOO	02/24/2021
IL RO LEE	02/24/2021
RECEIVING PARTY DATA	
Name:	SAMSUNG ELECTRO-MECHANICS CO., LTD.
Street Address:	MAEYOUNG-RO 150 (MAETAN-DONG), YOUNGTONG-GU
City:	SUWON-SI, GYEONGGI-DO
State/Country:	KOREA, REPUBLIC OF
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17233235
CORRESPONDENCE DATA	
Fax Number:	(202)739-3001
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	2027393000
Email:	wapatents@morganlewis.com, angie.ellis@morganlewis.com
Correspondent Name:	MORGAN, LEWIS & BOCKIUS LLP
Address Line 1:	1111 PENNSYLVANIA AVENUE, NW
Address Line 4:	WASHINGTON, D.C. 20004
ATTORNEY DOCKET NUMBER:	123193-8375-US
NAME OF SUBMITTER:	ANGELA Y. ELLIS
SIGNATURE:	/Angela Y. Ellis/

DATE SIGNED:	05/08/2021
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Total Attachments: 4
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source=Declaration-Assignment#page3.tif

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT6662510

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
JI HYE HAN	02/24/2021
JUNG MIN KIM	02/24/2021
JAE SEOK YI	02/24/2021
HYE JIN PARK	02/24/2021
BYUNG WOO KANG	02/26/2021
JEONG RYEOL KIM	03/02/2021
BON SEOK KOO	02/24/2021
IL RO LEE	02/24/2021
RECEIVING PARTY DATA	
Name:	SAMSUNG ELECTRO-MECHANICS CO., LTD.
Street Address:	MAEYOUNG-RO 150 (MAETAN-DONG), YOUNGTONG-GU
City:	SUWON-SI, GYEONGGI-DO
State/Country:	KOREA, REPUBLIC OF
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17233253 <u>17233253</u>
CORRESPONDENCE DATA	
Fax Number:	(202)739-3001
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	2027393000
Email:	wapatents@morganlewis.com, angie.ellis@morganlewis.com
Correspondent Name:	MORGAN, LEWIS & BOCKIUS LLP
Address Line 1:	1111 PENNSYLVANIA AVENUE, NW
Address Line 4:	WASHINGTON, D.C. 20004
ATTORNEY DOCKET NUMBER:	123193-8375-US
NAME OF SUBMITTER:	ANGELA Y. ELLIS
SIGNATURE:	/Angela Y. Ellis/
DATE SIGNED:	04/19/2021

other relevant treaties;

I hereby authorize and request the United States Patent and Trademark Office and officials in patent offices in foreign countries to issue any and all of said Letters Patent to the ASSIGNEE as the assignee of my entire right, title, and interest in and to the same, for the sole use and benefit of the ASSIGNEE, and its lawful successors and assigns, to the full end of the term for which said Letters Patent may be granted;

I hereby grant the attorney of record the power to insert on this Assignment any further identification that may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office or other authority for recordation of this document;

I hereby covenant that I have the full right to convey the interest assigned by this Assignment, and I have not executed and will not execute any agreement in conflict with this Assignment; and

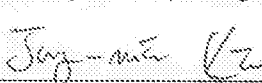
Further, I hereby further covenant and agree that I will, without further consideration, communicate with the ASSIGNEE, and its lawful successors and assigns, any facts known to me respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said ASSIGNEE, and its lawful successors or assigns, execute all divisional, continuation, continuation-in-part, and reissue applications, make all rightful oaths and generally do everything possible to aid the ASSIGNEE, and its lawful successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by the ASSIGNEE, and its lawful successors and assigns.

IN TESTIMONY WHEREOF, I have hereunto set my hands.

NAME OF INVENTOR (Full Legal Name): Ji Hye HAN

Signature:  Date: 2021. 2. 24

NAME OF INVENTOR (Full Legal Name): Jung Min KIM

Signature:  Date: 2021. 2. 24

NAME OF INVENTOR (Full Legal Name): Jae Seok YI

Signature:  Date: 2021. 2. 24


NAME OF INVENTOR (Full Legal Name): Hye Jin PARK

Signature:  Date: 2021. 2. 24

NAME OF INVENTOR (Full Legal Name): Byung Woo KANG

Signature:  Date: 2021. 2. 24

NAME OF INVENTOR (Full Legal Name): Jeong Ryeol KIM

Signature:  Date: 2021. 3. 2

Morgan, Lewis & Bockius LLP

PATENT

REEL: 056182 FRAME: 0637

NAME OF INVENTOR (Full Legal Name) : <u>Bon Seok KOO</u>	
Signature: <u>[Handwritten Signature]</u>	Date: <u>2 Feb. 24th, 2021</u>
NAME OF INVENTOR (Full Legal Name) : <u>Il Ro LEE</u>	
Signature: <u>[Handwritten Signature]</u>	Date: <u>2021. 02. 24</u>

SAMSUNG

JIHYE.HAN

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